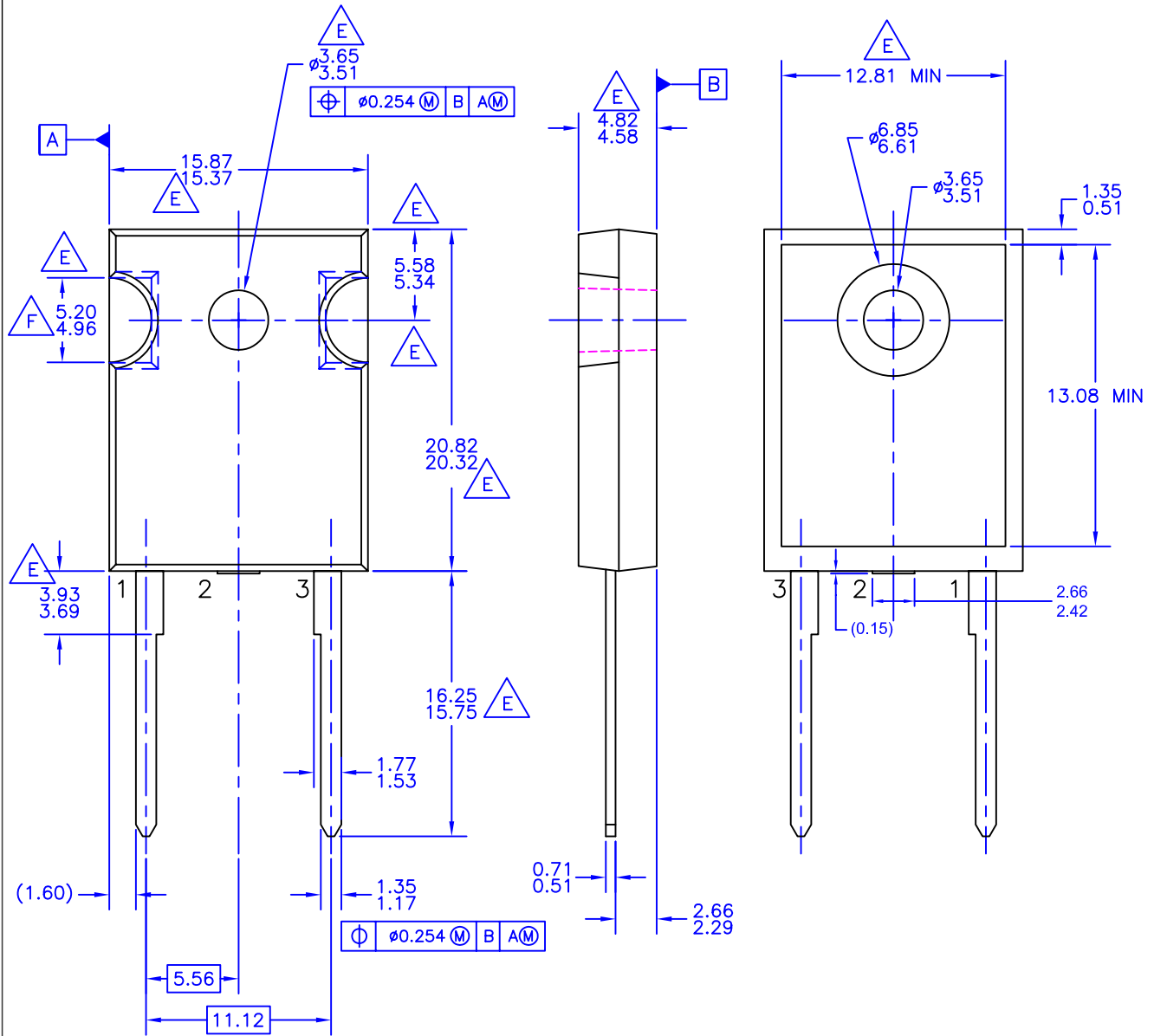


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REVISIONS				
NBR	DESCRIPTION	E.C.N.	DATE	BY/APP'D
1	RELEASE TO DOCUMENT CONTROL	XXX	29JAN2007	YS/FSSZ
2	CHANGE DIM FROM 13.46 TO 12.81 CHANGE TO NUMERICAL REVIS/DIM REMOVE SITE ADDRESS & FOLLOW NOTES AS PER MKT-FSC-0001_REV_05		17MAR2008	SDL/EE/FSSZ



- NOTES: UNLESS OTHERWISE SPECIFIED
- A. PACKAGE REFERENCE: JEDEC TO-247, ISSUE E, VARIATION AB, DATED JUNE, 2004.
 - B. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
 - C. ALL DIMENSIONS ARE IN MILLIMETERS.
 - D. DRAWING CONFORMS TO ASME Y14.5 - 1994
- E.** DOES NOT COMPLY JEDEC STANDARD VALUE
- F.** NOTCH MAY BE SQUARE
- G.** DRAWING FILENAME: MKT-TO247B02_REV02

APPROVALS	DATE	FAIRCHILD SEMICONDUCTOR™			
DRAWN: BOBOY MALDO	17MAR2008	TO-247, MOLDED, 2 LEADS, JEDEC OPTION AB			
CHECKED: FRED REN					
APPROVED: SD LEE					
H. ALLEN					
		SCALE 1:1	SIZE NA	DRAWING NUMBER MKT-TO247B02	REV 2
		FORMERLY: N/A	SHEET : 1 OF 1		